



Material Content Data Sheet



Sales Product Name	BF 2030 E6814			Issued		29. August 2013		
MA#	MA000744172							
Package	PG-SOT143-4-1			Weight*		11.07 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	noble metal	gold	7440-57-5	0.004	0.03		322	
	non noble metal	tin	7440-31-5	0.001	0.01		83	
	inorganic material	silicon	7440-21-3	0.031	0.28	0.32	2805	3210
leadframe	non noble metal	nickel	7440-02-0	1.673	15.12		151151	
	non noble metal	iron	7439-89-6	2.310	20.87	35.99	208732	359883
wire	noble metal	gold	7440-57-5	0.016	0.14	0.14	1419	1419
encapsulation	organic material	carbon black	1333-86-4	0.104	0.94		9416	
	inorganic material	antimonytrioxide	1309-64-4	0.156	1.41		14124	
	plastics	brominated resin	-	0.195	1.77		17655	
	plastics	epoxy resin	-	1.628	14.71		147127	
	inorganic material	silicondioxide	60676-86-0	4.428	40.02	58.85	400184	588506
leadfinish	non noble metal	tin	7440-31-5	0.217	1.96	1.96	19573	19573
plating	noble metal	silver	7440-22-4	0.303	2.74	2.74	27409	27409
*deviation	< 10%	Sum in total:			100,00		1000000	

Important Remarks:

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